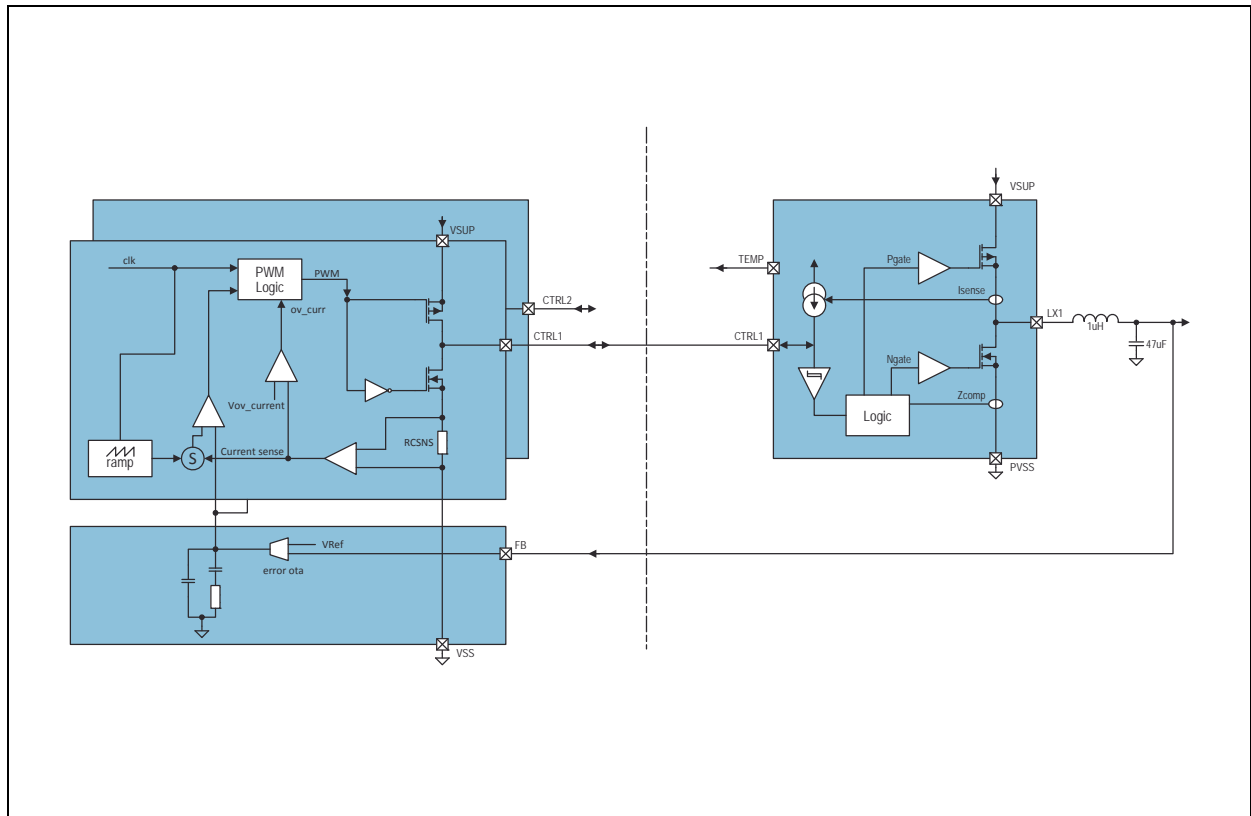


## Block Diagram

The functional blocks of this device are shown below:

**Figure 2:**  
**AS3729B Block Diagram**

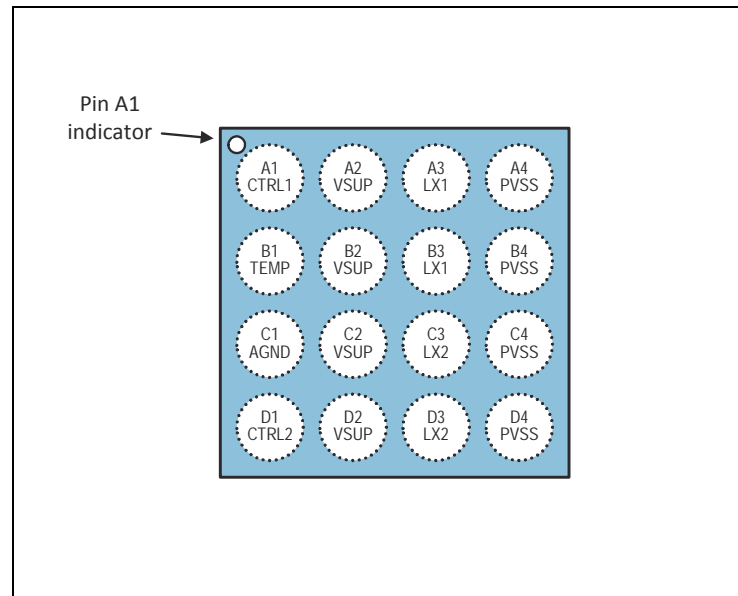


**AS3729B Block Diagram:** This figure shows the block diagram of the DC/DC controller inside the Main PMIC and the AS3729B Power Stage with all relevant system components.

## Pin Assignment

**Figure 3:**  
**16 Balls WL-CSP with 0.4mm Pitch**

**Pin Assignments:** Shows the top view pin assignment of the AS3729B



**Figure 4:**  
**Pin Description**

Pin Number	Pin Name	Description
A1	CTRL1	Control IO for phase 1
B1	TEMP	On/Off control and temperature feedback
C1	AGND	Analog ground
D1	CTRL2	Control IO for phase 2
A2, B2	VSUP	Phase 1 positive supply terminal
C2, D2	VSUP	Phase 2 positive supply terminal
A3, B3	LX1	Phase 1 switching output to coil
C3, D3	LX2	Phase 2 switching output to coil
A4, B4	PVSS	Phase 1 negative supply terminal
C4, D4	PVSS	Phase 2 negative supply terminal

## Absolute Maximum Ratings

Stresses beyond those listed under [Absolute Maximum Ratings](#) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under [Electrical Characteristics](#) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Figure 5:**  
**Absolute Maximum Ratings**

Symbol	Parameter	Min	Max	Units	Comments
<b>Electrical Parameters</b>					
	Supply voltage to ground 5V pins	-0.5	7.0	V	Applicable for pins VSUPx, LXx, CTRLx
	Supply voltage to ground 3V pins	-0.5	5.0	V	Applicable for pin TEMP
	Voltage difference between ground terminals	-0.5	0.5	V	Applicable for pins PVSS, AGND
	Input current (latch-up immunity)	-100	100	mA	Norm: JEDEC JESD78
<b>Continuous Power Dissipation (<math>T_A = 70^\circ\text{C}</math>)</b>					
$P_T$	Continuous power dissipation		1	W	$P_T^{(1)}$ for WL-CSP16 package ( $R_{THJA} \sim 55\text{K/W}$ )
<b>Electrostatic Discharge</b>					
$\text{ESD}_{\text{HBM}}$	Electrostatic discharge HBM	$\pm 2$		kV	Norm: JEDEC JESD22-A114F

Symbol	Parameter	Min	Max	Units	Comments
<b>Temperature Ranges and Storage Conditions</b>					
$T_A$	Operating temperature	-40	85	°C	
$R_{THJA}$	Junction to ambient thermal resistance			°C/W	$R_{THJA}$ typ. 55K/W
$T_J$	Junction temperature		125	°C	
$T_{STRG}$	Storage temperature range	-55	125	°C	
$T_{BODY}$	Package body temperature		260	°C	Norm IPC/JEDEC J-STD-020 <sup>(2)</sup>
$RH_{NC}$	Relative humidity (non condensing)	5	85	%	
MSL	Moisture sensitivity level	1			Represents an unlimited floor life time

**Note(s) and/or Footnote(s):**

1. Depending on actual PCB layout and PCB used
2. The reflow peak soldering temperature (body temperature) is specified according IPC/JEDEC J-STD-020 "Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices"

## Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

**Figure 6:**  
Electrical Characteristics

Symbol	Parameter	Note	Min	Typ	Max	Unit
$V_{IN}$	Input voltage	Pin VSUPx	2.5		5.5	V
		Pin CTRLx	0		5.5	V
		Pin TEMP	0		3.6	V
$I_{LIMIT}$	Peak coil current limit	Single phase			4.8	A
$I_{LOAD}$	Load current single phase	Continuous load current	0		3	A
		Peak load current			4 <sup>(1)</sup>	
$R_{PMOS}$	P-switch ON resistance <sup>(2)</sup>	Single phase		40	70	mΩ
$R_{NMOS}$	N-switch ON resistance <sup>(2)</sup>	Single phase		20	35	mΩ
$f_{SW}$	Switching frequency	Supplied by DC/DC controller		1.3	3	MHz
$I_{Q\_force\_PWM}$	Quiescent current PWM	TEMP pin high, force PWM mode active		6.2		mA
$I_{Q\_low\_power}$	Quiescent current LP	TEMP pin high, low power mode active		21		μA
$I_{power\_off}$	Power-Off current	No current into pin TEMP		±1		μA
$R_{discharge}$	Active discharge	Single phase		16		Ω

**Electrical Characteristics:** Shows the Electrical Characteristics of the Step Down DC/DC Power Stage. VSUP = 3.8V,  $T_A = 25^{\circ}\text{C}$  (unless otherwise specified)

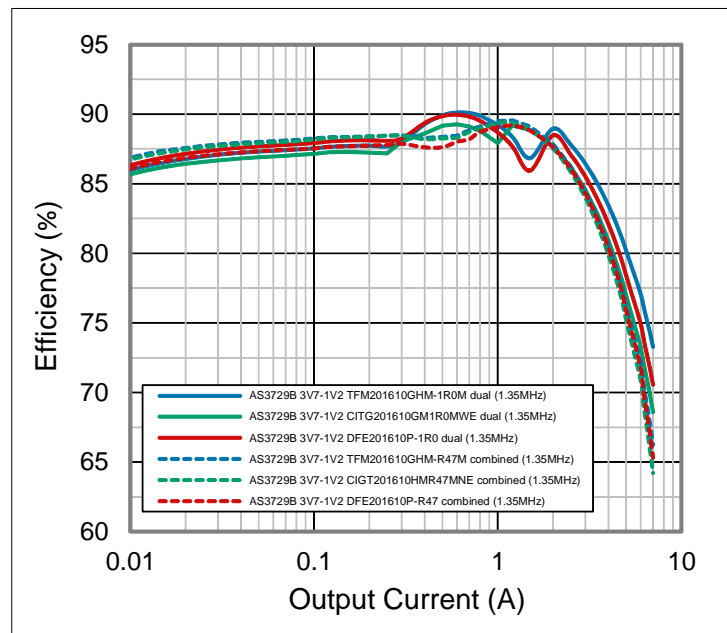
**Note(s) and/or Footnote(s):**

- Maximum value only for pulsed peak current
- MOS transistor only without package parasitic

## Typical Operating Characteristics

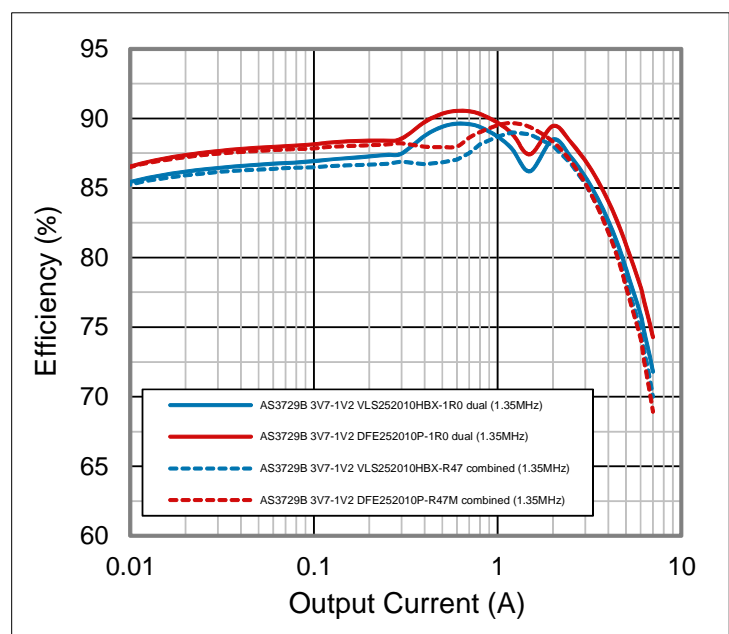
**AS3729B Step Down DC/DC:** Shows the Efficiency of AS3729B of various coil types in a 2016 package in dual and combined mode. For the dual mode two 1uH coils are used and for the combined mode one 470nH coil. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation,  $T_A = 25^\circ\text{C}$

**Figure 7:**  
Efficiency vs. Output Current for 2016 Coil Types



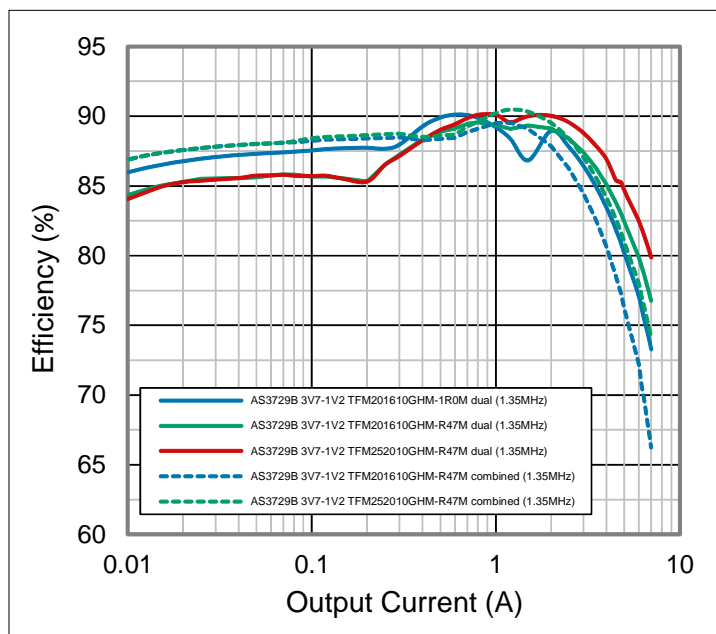
**Figure 8:**  
Efficiency vs. Output Current for 2520 Coil Types

**AS3729B Step Down DC/DC:** Shows the Efficiency of AS3729B of various coil types in a 2520 package in dual and combined mode. For the dual mode two 1uH coils are used and for the combined mode one 470nH coil. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation,  $T_A = 25^\circ\text{C}$



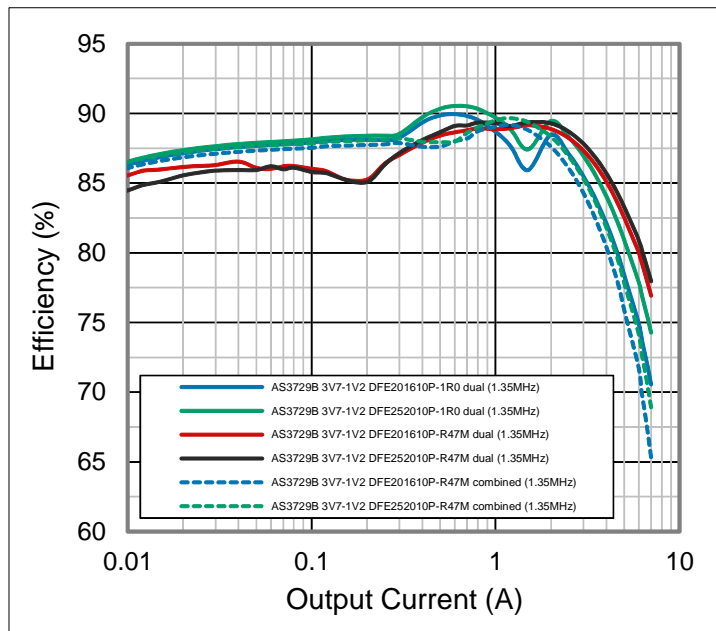
**Figure 9:**  
Efficiency vs. Output Current for Various TDK Coils

**AS3729B Step Down DC/DC:** Shows the Efficiency of AS3729B of various TDK coils in dual and combined mode. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation,  $T_A = 25^\circ\text{C}$



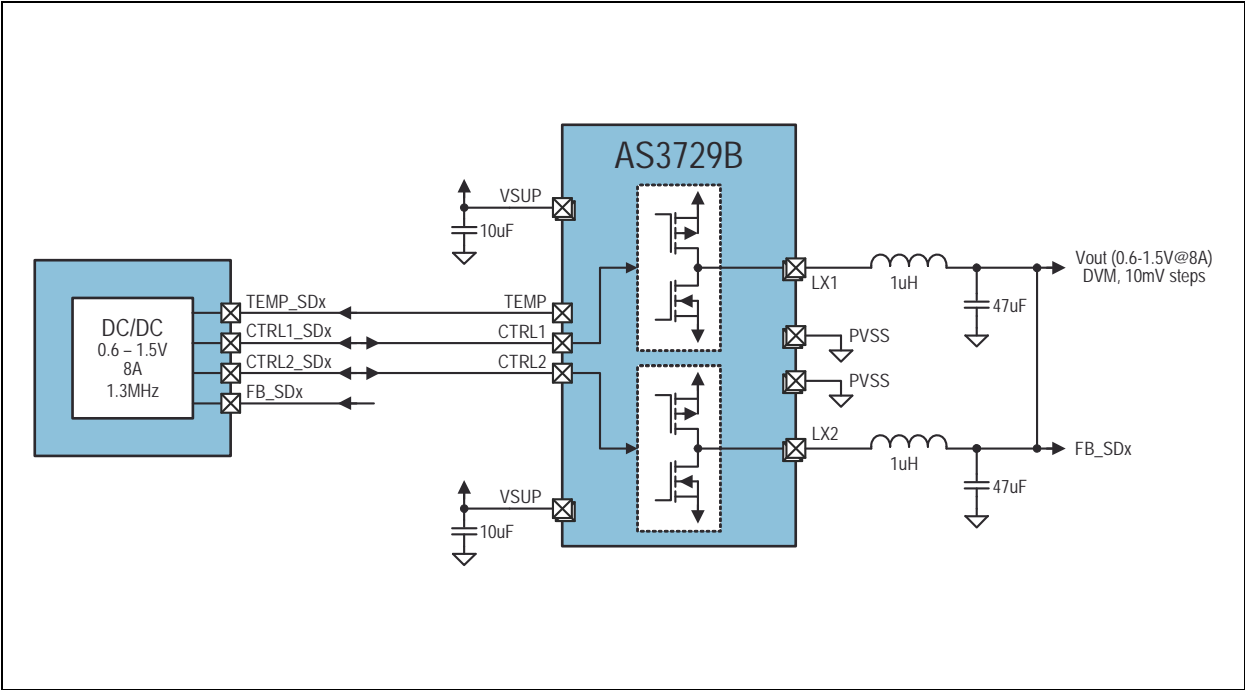
**Figure 10:**  
Efficiency vs. Output Current for Various Toko Coils

**AS3729B Step Down DC/DC:** Shows the Efficiency of AS3729B of various Toko coils in dual and combined mode. VSUP = 3.7V, VOUT = 1.2V, 1.35MHz operation,  $T_A = 25^\circ\text{C}$



Application Information

Figure 11:  
Typical Application Circuit



**AS3729B Typical Application:** This figure shows the connection of the DC/DC controller and the AS3729B Power Stage.

External Components

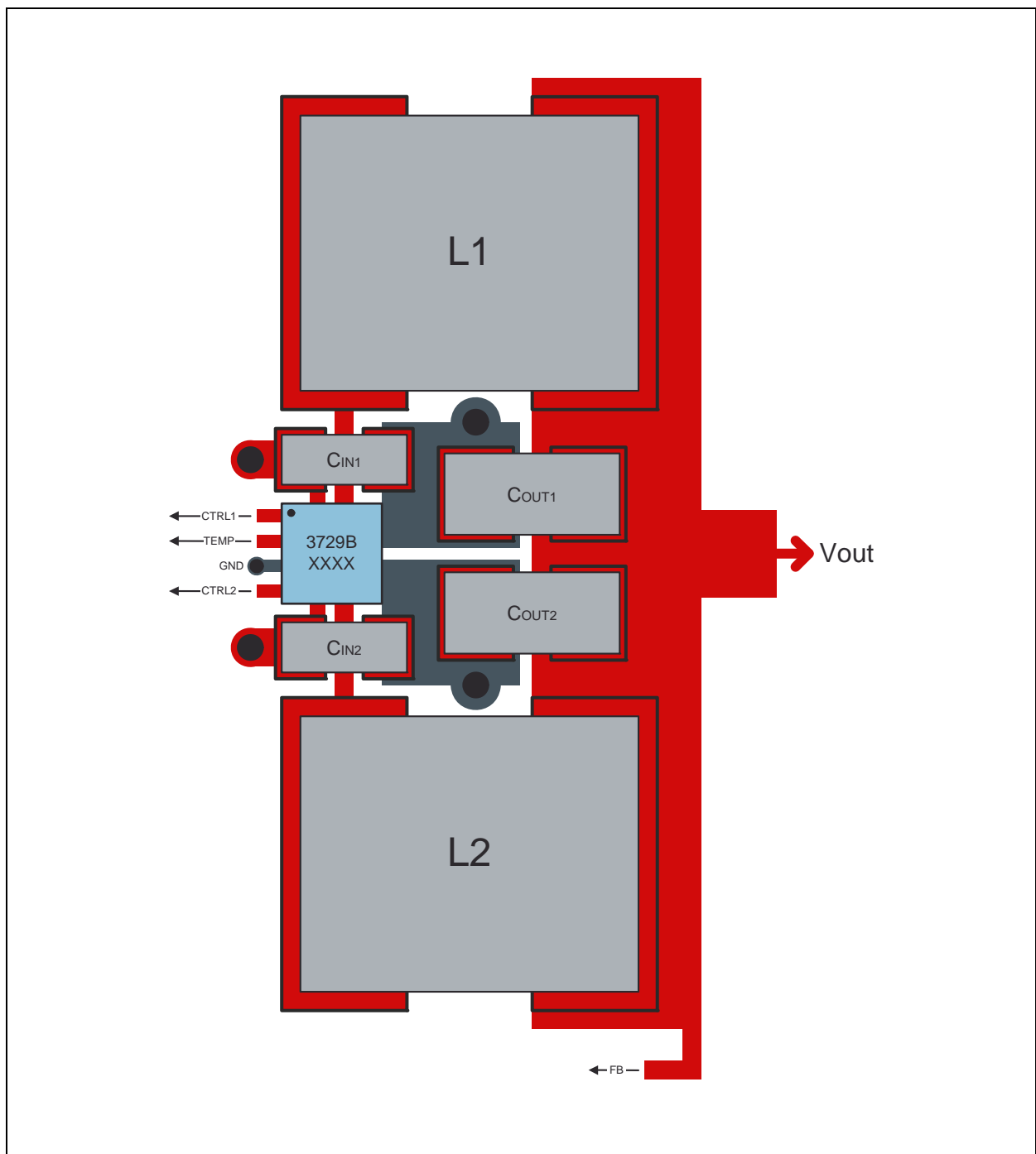
Figure 12:  
Step Down DC/DC Power Stage External Components

Symbol	Parameter	Note	Min	Typ	Max	Unit
External Components per Phase						
C <sub>FB</sub>	Output Capacitor	Ceramic X5R or X7R, high performance	64	82		μF
		Ceramic X5R or X7R, cost optimized	32	47		μF
C <sub>VSUP</sub>	Input Capacitor	Ceramic X5R or X7R	6	10		μF
L	Inductor	5A rated, 1.3MHz operation, low R <sub>ON</sub>	0.5	1		μH

**External Components:** Shows the recommended values of the needed external components of the Step Down DC/DC Power Stage

## PCB Layout

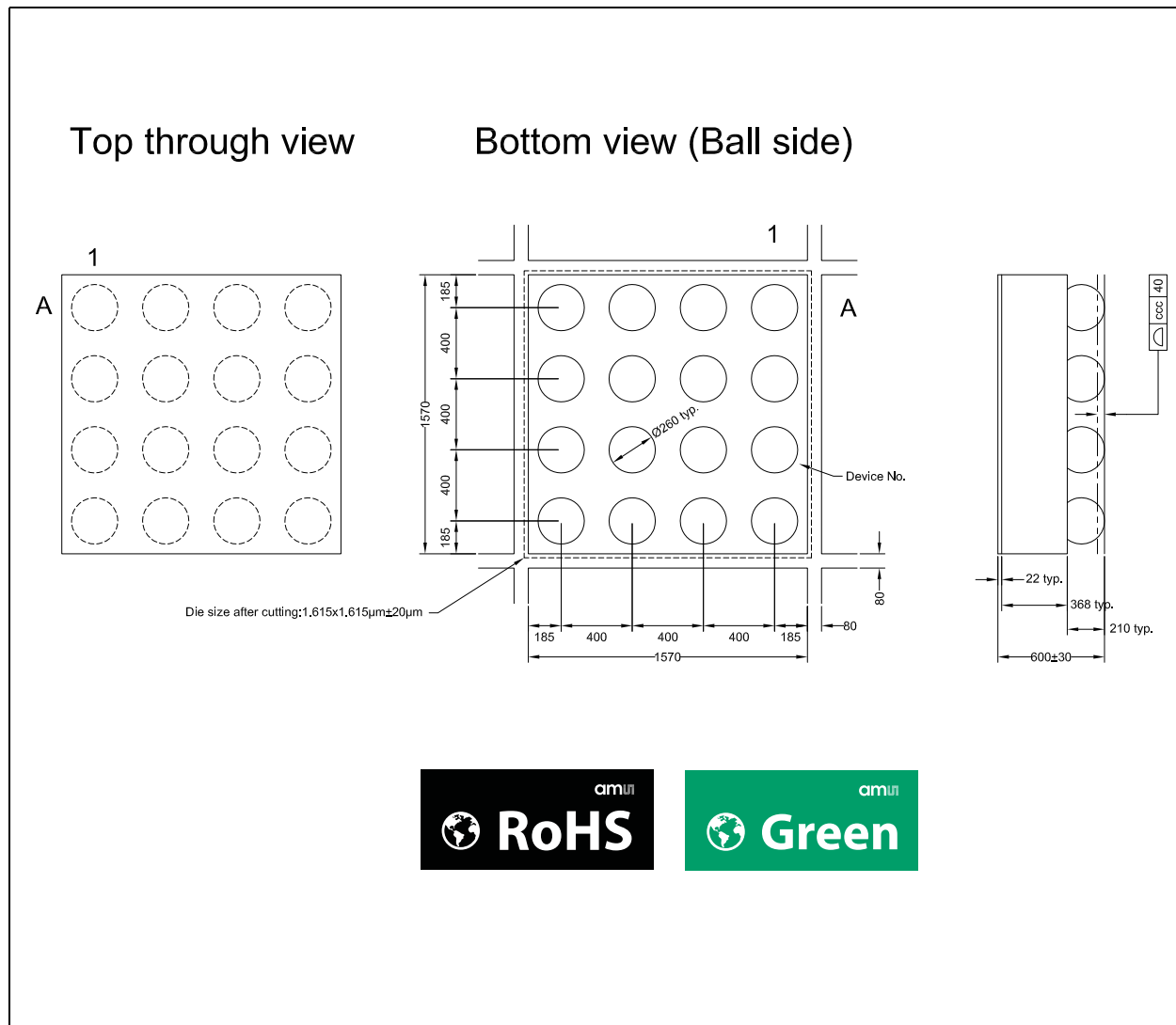
**Figure 13:**  
Layout Guidelines



**Layout Guidelines:** This figure shows the recommended layout and placement of the external components for the 2-phase AS3729B Power Stage

## Package Drawings & Markings

**Figure 14:**  
**16-Pin WL-CSP with 0.4mm Pitch**



**Note(s) and/or Footnote(s):**

1. Pin 1= A1
2. ccc coplanarity
3. All dimensions in  $\mu\text{m}$

Figure 15:  
16-Pin WL-CPS Marking

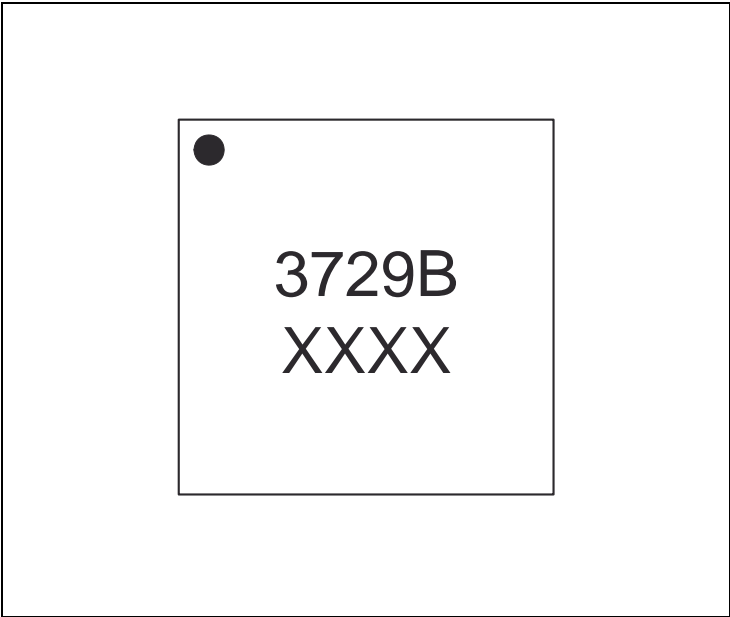


Figure 16:  
Packaging Code

XXXX
Tracecode

## Ordering & Contact Information

**Figure 17:**  
**Ordering Information**

Ordering Code	Package	Marking	Delivery Form	Delivery Quantity
AS3729B-BWLM	16-pin WL-CSP	3729B	Tape & Reel	500 pcs/reel
AS3729B-BWLT				12000 pcs/reel

Buy our products or get free samples online at:

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### Headquarters

ams AG  
Tobelbaderstrasse 30  
8141 Unterpremstaetten  
Austria, Europe

Tel: +43 (0) 3136 500 0

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## Revision Information

Changes from 1-01 (2014-Mar) to current revision 1-03 (2015-Sep-28)	Page
<b>1-01 (2014-Mar) to 1-02 (2015-Sep-21)</b>	
Content was updated to the latest <b>ams</b> design	
Updated Figure 16	12
Updated Figure 17	13
<b>1-02 (2015-Sep-21) to 1-03 (2015-Sep-28)</b>	
Updated Figure 14	11

**Note(s) and/or Footnote(s):**

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
2. Correction of typographical errors is not explicitly mentioned.

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1	Applications
2	Block Diagram
<b>3</b>	<b>Pin Assignment</b>
<b>4</b>	<b>Absolute Maximum Ratings</b>
<b>6</b>	<b>Electrical Characteristics</b>
<b>7</b>	<b>Typical Operating Characteristics</b>
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